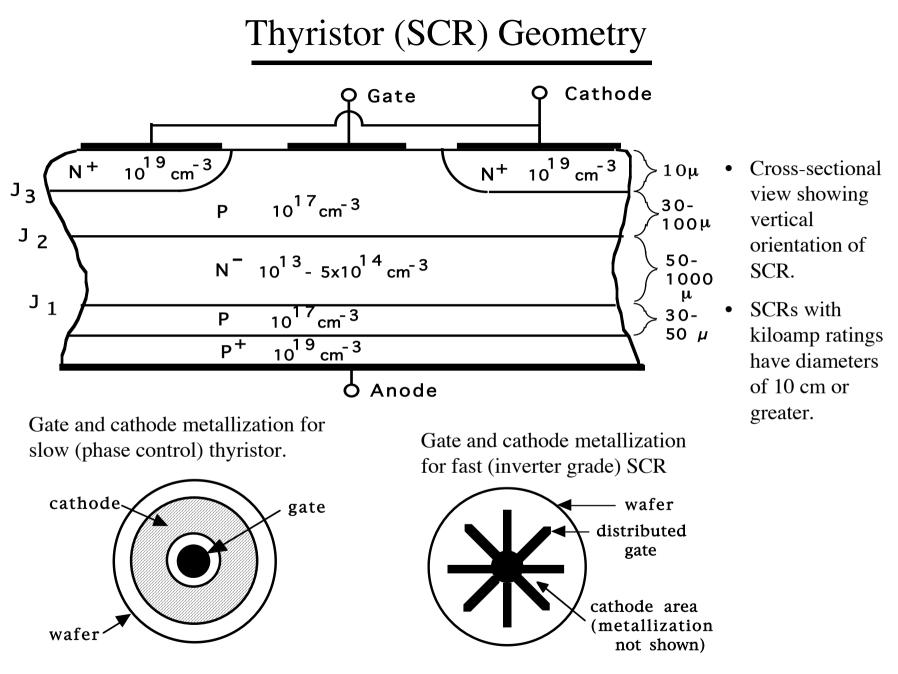
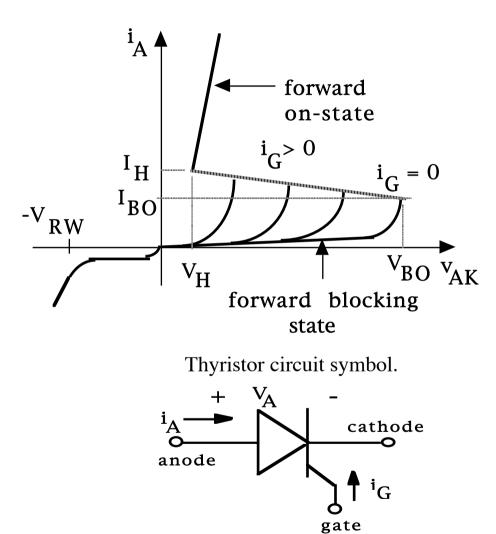
# Lecture Notes <u>Thyristors (SCRs</u>)

#### <u>OUTLINE</u>

- SCR construction and I-V characteristics.
- Physical operation of SCRs.
- Switching behavior of SCRs
- dv/dt and di/dt limitations and methods of improving them.
- SCR drive circuit considerations.



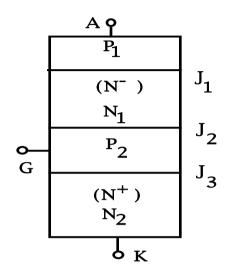
# **Thyristor I-V Characteristics**



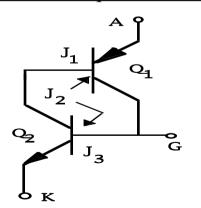
- SCR triggerable from forward blocking state to on-state by a gate current pulse.
- Thyristor latches on and gate cannot turn it off. External circuit must force SCR off.
- Current to several kiloamps for V(on) of 2-4 volts.
- Blocking voltages to 5-8 kilovolts.
- $V_{BO}$  = breakover voltage ;  $I_{BO}$  = breakover current
- $V_H$  = holding voltage  $I_H$  = holding current
- Maximum junction temperature = 125 C limited by temperature dependence of V<sub>BO</sub>.

# **SCR Model and Equivalent Circuit**

One dimensional SCR model.



Two transistor equivalent circuit



- BJTs in equivalent circuit in active region.
- Use Ebers-Moll equations for BJTs

• 
$$I_{C1} = -\alpha_1 I_{E1} + I_{CO1}$$
;  $I_{C2} = -\alpha_2 I_{E2} + I_{CO}$ 

• 
$$I_A = I_{E1}$$
;  $I_K = -I_{E2} = I_A + I_G$ 

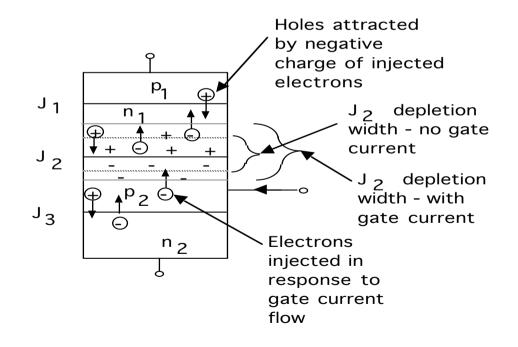
• 
$$I_{C1} + I_{B1} + I_{E1} = 0$$

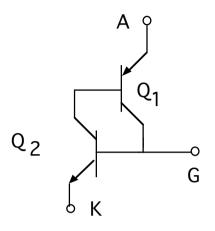
• 
$$I_A = \frac{\alpha I_G! + I_{CO1}! + I_{CO2}}{1! - I_{1}! - I_{2}! \alpha_2}$$

- Blocking state  $\alpha_1 + \alpha_2 << 1$
- At breakover  $\alpha_1 + \alpha_2 \approx 1$

## **Thyristor Turn-on Process**

- In forward blocking state, both BJTs active.
- If  $\alpha_1 + \alpha_2 < 1$ , connection is stable.
- If  $V_{AK} = V_{BO}$  or if positive gate current pulse is applied  $\alpha_1 + \alpha_2$  becomes equal to unity and circuit connection becomes unstable and SCR switches on.

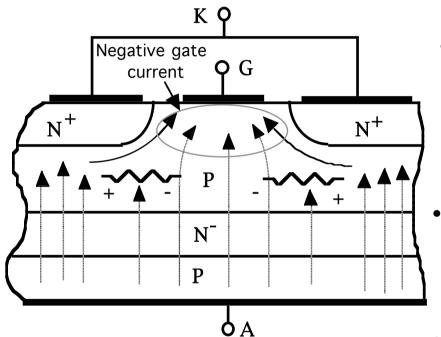




- Negative charge of electrons swept into  $n_1$ layer partially compensate positive charge of ionized donors exposed by growth of depletion of junction  $J_2$ .
- Growth of depletion reduces width of bases of  $Q_{npn}$  and  $Q_{pnp}$  and thus increases  $\alpha_1$  and  $\alpha_2$ .
- Holes attracted by first wave of injected electrons attract additional electrons and so on regenerative action.

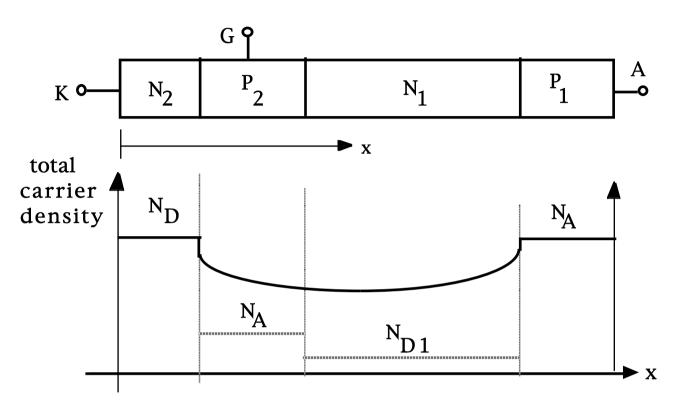
# **Thyristor On-state Latchup**

#### SCR with negative gate current



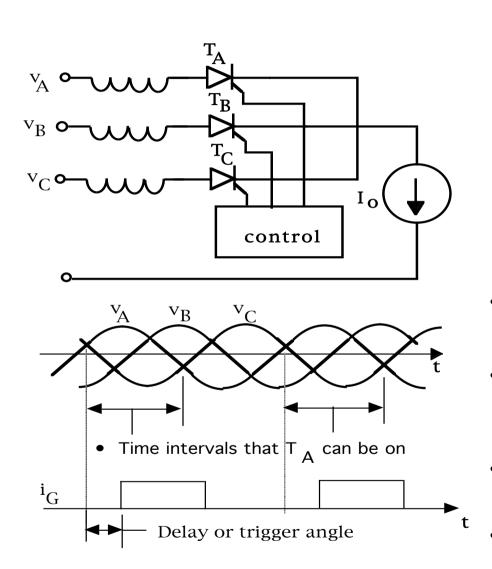
- Negative gate current causes lateral voltage drops as indicated which lead to current crowding in center of cathode.
- Conventional SCRs (phase control) have large area cathodes - negative gate current cannot remove stored charge from center of large cathode area.
- SCR stays latched on in spite of negative gate current.
- External circuit must force anode current to negative values in order that enough stored charge be removed from SCR so that it can turn off.

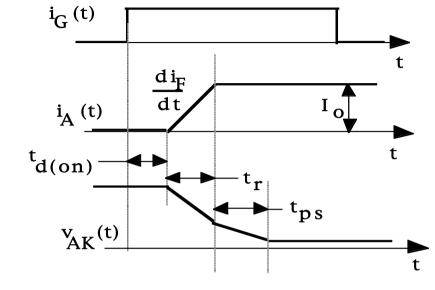
#### **Thyristor On-state Operation**



- On-state: all three junctions forward biased and BJTs in equivalent circuit saturated.
- On-state stable because saturated BJTs have  $\alpha_1 + \alpha_2 \ll 1$ .
- On-state voltage  $V_{AK(on)} = V_{j1} V_{j2} + V_{j3} + V_n$

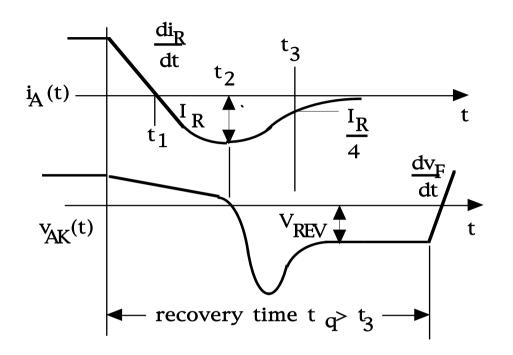
#### **Thyristor Turn-on Behavior**





- $t_{d(on)}$  = turn-on delay time; time required for charge injection by gate current to make  $\alpha_1 + \alpha_2 = 1$ .
- $t_r$  = time required for anode current to reach on-state value. Anode current rate-of-rise di<sub>F</sub>/dt limited by external inductance.
- t<sub>ps</sub> = time required for plasma to spread over whole cathode area from cathode periphery near gate.
- $V_{AK}$  does not attain on-state value until complete area of cathode is conducting.

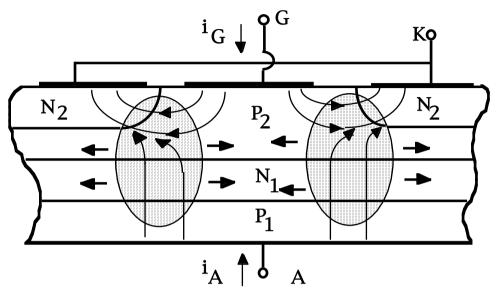
## **Thyristor Turn-off Behavior**



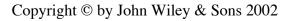
Turn-off waveforms

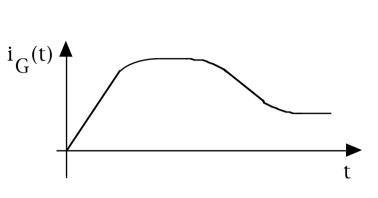
- SCR turn-off quite similar to power diode turn-off.
- Anode current rate-of-fall controlled by external inductance.
- Reverse voltage overshoot caused by external inductance.
- Junction  $J_1$  is blocking junction in reverse bias.  $J_3$  has low breakdown voltage (20-40 volts) because of the heavy doping on both sides of the junction.

#### **Thyristor di/dt Limit at Turn-on**



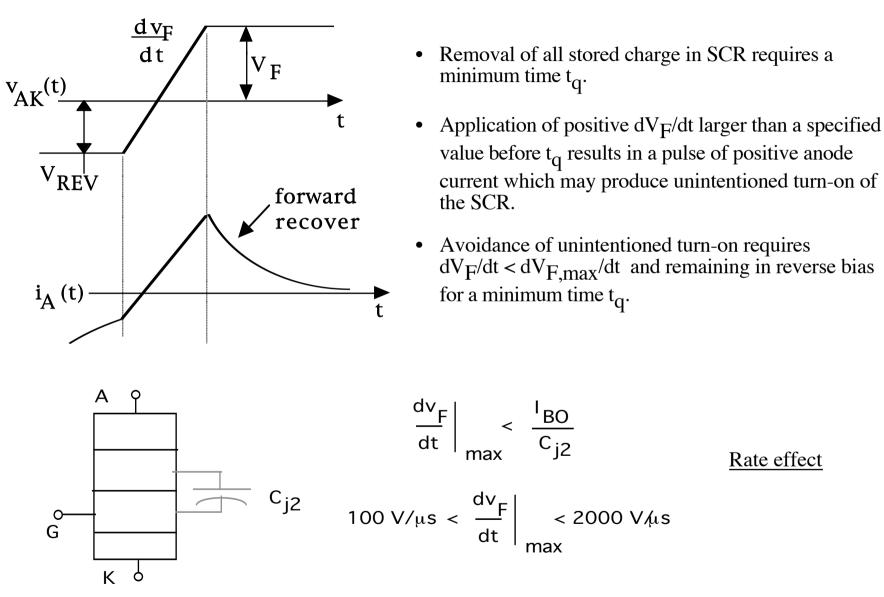
- SCR first turns on at cathode periphery nearest gate.
- Current constricted to small areas during initial phases of turnon,  $t_{d(on)}$  and  $t_{r}$ .
- If anode current rate-of-rise, di<sub>F</sub>/dt, not kept less than some specified maximum, current density in constricted area will be too large.
- Localized power dissipation too high and thermal runaway likely.





• Use shaped gate current pulse for rapid turn-on.

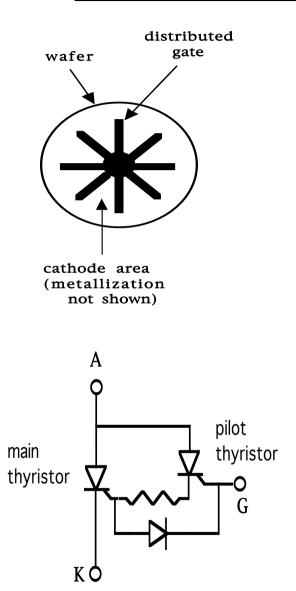
# **Thyristor Re-applied dv/dt Limits**



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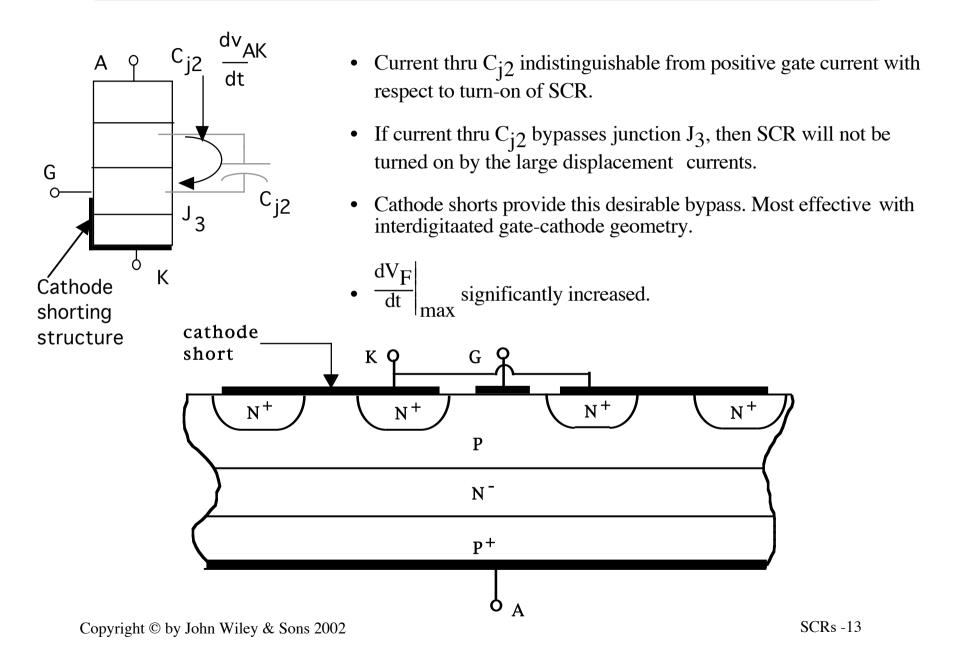
SCRs -11

# **Methods of Improving Thyristor di/dt Rating**



- Interdigitated gate-cathode structure used to greatly increase gate-cathode periphery.
- Distance from periphery to center of any cathode region significantly shortened.
- Ability of negative gate current to break latching condition in on-state increased.
- Combination of pilot thyristor, diode, and iterdigitated gate-cathode geometry tgermed a gate-assisted turn-off thyristor or GATT
- Use of pilot thyristor to increase turn-on gate current to main thyristor.
- Larger gate current increases amount of initial conducting area of cathode and thus improves di<sub>F</sub>/dt capabilities.
- Diode allowes negative gate current to flow from main SCR.

# **Improvement in dv/dt Rating Via Cathode Shorts**



### **Thyristor Gate Trigger Requirements**

